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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAMON MOAZEN	11/07/2013
ROBERT G. LAMONT	11/08/2013
ROBERT R. TONG	11/07/2013
NAVIN N. BUNYAN	11/08/2013

RECEIVING PARTY DATA

Name:	BOSTON SCIENTIFIC NEUROMODULATION CORPORATION	
Street Address:	25155 RYE CANYON LOOP	
City:	VALENCIA	
State/Country:	CALIFORNIA	
Postal Code:	91355	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14525941

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	TERRIL LEWIS
SIGNATURE:	/Terril Lewis/
DATE SIGNED:	10/28/2014

Total Attachments: 1

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PATENT REEL: 034053 FRAME: 0106

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COMBINED DECLARATION & ASSIGNMENT

Attorney Docket No.: 585-0148PUS

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Client Ref. No.: BSC 13-0350PV01

Title: Circuit Board for an Implantable Medical Device, and Method of Fabricating and Testing

ASSIGNMENT

WHEREAS, I, Damon Moazen, Robert G. Lamont, Robert R. Tong, Navin N. Bunyan, have invented certain new and useful improvements as described in U.S. patent application Circuit Board for an Implantable Medical Device, and Method of Fabricating and Testing, the application having been executed on even date herewith; and

WHEREAS, Boston Scientific Neuromodulation Corporation, a Corporation of the State of Delaware, and having an address of 25155 Rye Canyon Loop, Valencia, CA, 91355 (together with its successors and assigns, the "Assignee"), seeks to memorialize its ownership of the entire right, title and interest in and to the Invention;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, I transfer to Assignee my entire right, title, and interest in and to the Invention, including all inventions disclosed or claimed in the above-identified patent application, including any improvements thereof, any corresponding domestic applications (e.g., provisional, non-provisional, divisional, continuation, continuation-in-part, reexamination, and/or reissue patent), any corresponding foreign applications, all patents issuing thereon, or other patent application based off or claiming priority to the above-identified patent application, and all rights and benefits under any applicable treaty or convention. I authorize the USPTO (or foreign equivalent thereof) to issue any patent (or similar legal protection) to the Assignee.

I authorize the Assignee to insert in this instrument the filing date and application number of the application when ascertained. I hereby authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries.

I represent to the Assignee that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I agree when requested, without additional consideration, but at the expense of the Assignee, to provide additional reasonable assistance necessary to memorialize this assignment, to execute all oaths, declarations, assignments, powers of attorney and other papers necessary to perfect and vest title to the rights assigned herein to the Assignee; and will render all assistance in filing, obtaining, maintaining, and enforcing any patent (or similar legal protection) on the Invention in any and all countries.

DECLARATION

I have reviewed and understand the contents of the above-identified patent application including the claims, and I believe I am an original or an original joint inventor of a claimed invention in the above-identified patent application. The above-identified patent application was made or authorized to be made by me. I am aware of and acknowledge my duty to disclose to the USPTO all information known to me to be material to patentability of the claims in the above-identified patent application. I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Damon Monzen

Robert G. Lamont

Date 07 NOV 2013

- X K WY

Robert R. Tong

Navin N. Bunyan

Date 17 NOV 2013

Date OF NOV 2013

PATENT REEL: 034053 FRAME: 0107

RECORDED: 10/28/2014